Silicon Carbide Schottky Diode

650 V, 6 A

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 20 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

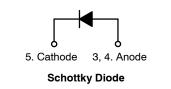
Applications

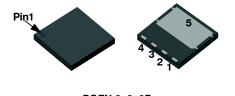
- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits



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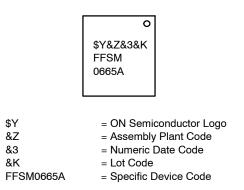
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PQFN 8×8, 2P CASE 483AP

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FFSM0665A

Symbol	Parameter	Value	Unit	
V _{RRM}	Peak Repetitive Reverse Voltage	petitive Reverse Voltage		V
E _{AS}	Single Pulse Avalanche Energy	(Note 1)	20	mJ
١ _F	Continuous Rectified Forward Current @ $T_C < 150^{\circ}C$		6	А
	Continuous Rectified Forward Current @ $T_C < T_C$	nuous Rectified Forward Current @ T _C < 135°C		
I _{F, Max}	Non-Repetitive Peak Forward Surge Current	T _C = 25°C, 10 μs	430	A
		T _C = 150°C, 10 μs	415	А
I _{F,SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	42	А
I _{F,RM}	Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	20	A
Ptot	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	56	W
		T _C = 150°C	9.4	W
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +175	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E_{AS} of 20 mJ is based on starting T_J = 25°C, L = 1 mH, I_{AS} = 9 A, V = 50 V.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	2.67	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 6 A, T _C = 25°C	-	1.50	1.75	V
		I _F = 6 A, T _C = 125°C	-	1.6	2.0	
		I _F = 6 A, T _C = 175°C	-	1.72	2.4	
I _R	Reverse Current	$V_{R} = 650 \text{ V}, \text{ T}_{C} = 25^{\circ}\text{C}$	-	-	200	μΑ
		$V_{R} = 650 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	400	
		$V_{R} = 650 \text{ V}, \text{ T}_{C} = 175^{\circ}\text{C}$	-	-	600	
Q _C	Total Capacitive Charge	V = 400 V	-	22	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	365	-	pF
		V _R = 400 V, f = 100 kHz	-	40	-	1
		V _R = 800 V, f = 100 kHz	-	31	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping [†]
FFSM0665A	FFSM0665A	PQFN 8x8, 2P (Pb–Free/Halogen Free)	3000Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

FFSM0665A

TYPICAL CHARACTERISTICS

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

Tj = 175 ℃

TJ = 125 °C

600

150

100

650

175

650

Tj = 75

25

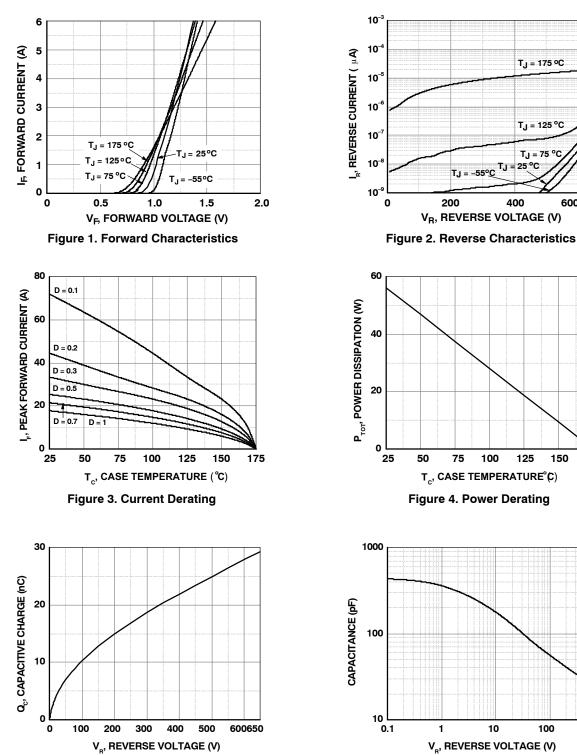
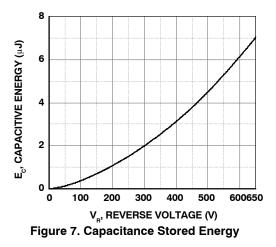


Figure 5. Capacitive Charge vs. Reverse Voltage Figure 6. Capacitance vs. Reverse Voltage

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TYPICAL CHARACTERISTICS

(T_J = 25° C unless otherwise noted)



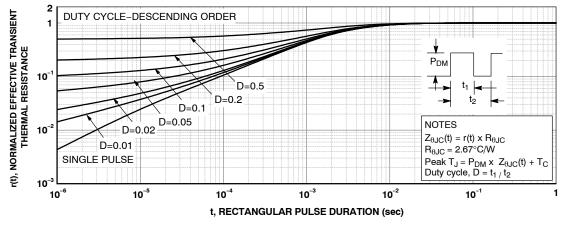
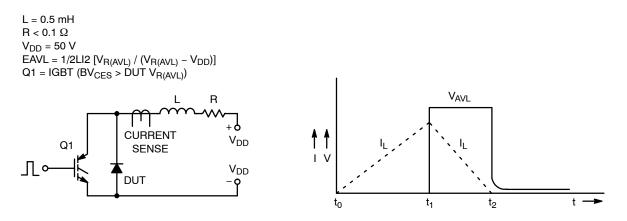


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

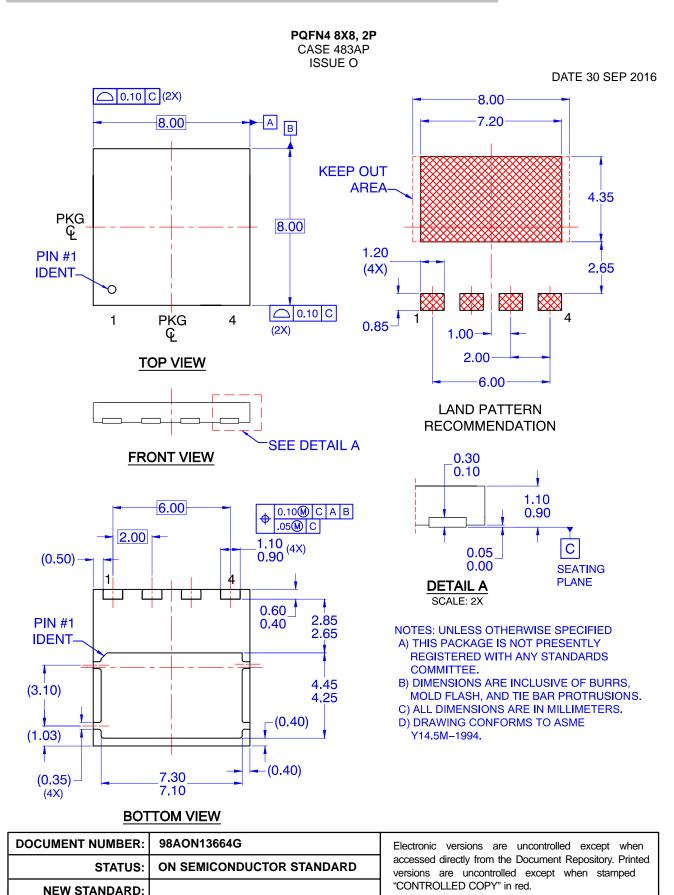




DESCRIPTION:

PQFN4 8X8, 2P





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DOCUMENT NUMBER: 98AON13664G

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